

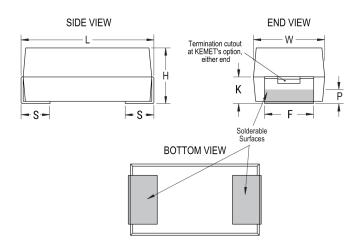


Aliases (T429X157K010AC)

General Information

Series

T429 CWR29, Tantalum, MnO2 Tantalum, Military/High Reliability, 150 uF, 10%, 10 VDC, SMD, MnO2, Molded, Military Equivalent, Low ESR, A (Non-ER), 65 mOhms, 6954, Height Max = 3.12mm



MnO2 Tantalum Dielectric Style SMD Chip Description SMD, MnO2, Molded, Military Equivalent, Low ESR RoHS No 🛕 WARNING: Cancer and reproductive harm – Prop 65 http://www.p65warnings.ca.gov. SCIP Number 652b281f-d242-4453-bc44-0655d646cec3 Termination Hot Solder Dipped Qualifications MIL-PRF-55365/11, CWR29 Style AEC-Q200 No Component 590.44 mg Weight Note: When Option C Is Selected For Lead Notes Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S". MSL 1

T429 CWR29

Click here for the 3D model.

Footprint 6954	
L 6.93mm +/-0.38mm	
W 5.41mm +/-0.38mm	
H 2.74mm +/-0.38mm	
S 1.19mm +0.25/-0.13mm	
F 3.05mm +/-0.13mm	
K 1.22mm MIN	
P 0.61mm MIN	

Packaging Specifications	,
Packaging	T&R, 178mm
Packaging Quantity	500

Specifications	
Capacitance	150 uF
Capacitance Tolerance	10%
Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	10% 120Hz 25C
Failure Rate	A (Non-ER)
Resistance	0.065 Ohms (100kHz 25C)
Leakage Current	15 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

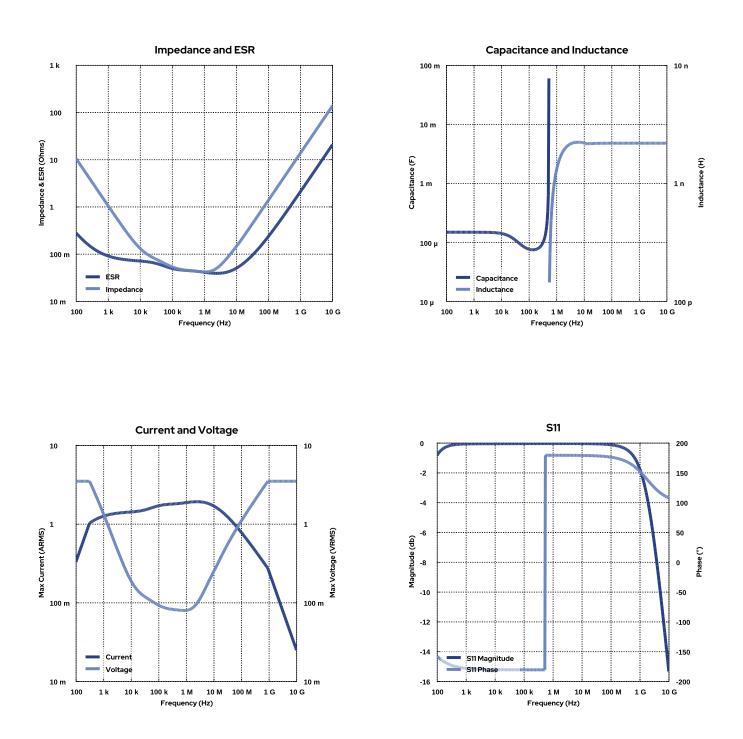


CWR29FC157KAX Aliases (T429X157K010AC)

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Simulations

For the complete simulation environment please visit K-SIM.

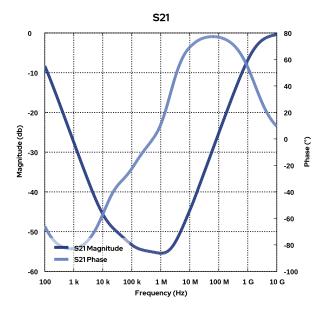






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CWR29FC157KAX

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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance. The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- harmonics
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)